

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Demian Gordon</td> <td>08/27/2007</td> </tr> <tr> <td>Parag Havaladar</td> <td>10/04/2007</td> </tr> </tbody> </table>		Name	Execution Date	Demian Gordon	08/27/2007	Parag Havaladar	10/04/2007				
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RECEIVING PARTY DATA											
<table border="1" style="width:100%; border-collapse: collapse;"> <tr> <td style="width:20%;">Name:</td> <td>Sony Corporation</td> </tr> <tr> <td>Street Address:</td> <td>1-7-1 Konan, Minato-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>108-0075</td> </tr> </table>		Name:	Sony Corporation	Street Address:	1-7-1 Konan, Minato-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	108-0075
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CORRESPONDENCE DATA											
Fax Number: (619)235-0398 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 619-238-1900 Email: docketing@procopio.com Correspondent Name: Procopio, Cory, Hargreaves & Savitch LLP Address Line 1: 530 B Street, Suite 2100 Address Line 4: San Diego, CALIFORNIA 92101											
ATTORNEY DOCKET NUMBER:	113748-6017US										

CH \$40.00 11829731

NAME OF SUBMITTER:

Samuel S. Lee

Total Attachments: 2

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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in FACS SOLVING IN MOTION CAPTURE (Application Number: 11/829,731, Filing Date: July 27, 2007) for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address.

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo 108-0075, Japan, and SONY PICTURES ENTERTAINMENT INC., a Delaware corporation, with offices at 10202 West Washington Boulevard, Culver City, California 90232 (hereinafter referred to as ASSIGNEES) are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at their own expense;

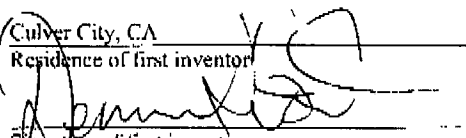
And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the dates indicated below.

Demian Gordon
Name of first inventor

Culver City, CA
Residence of first inventor


Signature of first inventor

Aug 27/07
Date of Assignment

Parag Havaldar
Name of second inventor

Cerritos, CA
Residence of second inventor

Signature of second inventor

Date of Assignment

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Culver City, CA
Residence of first inventor

Signature of first inventor

Date of Assignment

Parag Havaldar
Name of second inventor

Cerritos, CA
Residence of second inventor

Parag Havaldar
Signature of second inventor

Oct 4, 2007
Date of Assignment